

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2716478

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>WHAN OH SUNG</td> <td>09/12/2013</td> </tr> <tr> <td>JOOYEON LEE</td> <td>09/13/2013</td> </tr> <tr> <td>KYU EUN HWANG</td> <td>09/13/2013</td> </tr> <tr> <td>YOUNGKEUN LEE</td> <td>09/11/2013</td> </tr> <tr> <td>JOCHEN BACKS</td> <td>11/05/2013</td> </tr> </tbody> </table>		Name	Execution Date	WHAN OH SUNG	09/12/2013	JOOYEON LEE	09/13/2013	KYU EUN HWANG	09/13/2013	YOUNGKEUN LEE	09/11/2013	JOCHEN BACKS	11/05/2013
Name	Execution Date												
WHAN OH SUNG	09/12/2013												
JOOYEON LEE	09/13/2013												
KYU EUN HWANG	09/13/2013												
YOUNGKEUN LEE	09/11/2013												
JOCHEN BACKS	11/05/2013												
RECEIVING PARTY DATA													
Name:	SAMSUNG ELECTRONICS CO., LTD.												
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU, SUWON-SI, GYEONGGI-DO 443-742												
City:	SUWON-SI												
State/Country:	KOREA, REPUBLIC OF												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>29466175</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	29466175								
Property Type	Number												
Application Number:	29466175												
CORRESPONDENCE DATA													
Fax Number:	(202)315-3758												
Phone:	202-429-0020												
Email:	pto@nsiplaw.com												
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>													
Correspondent Name:	NSIP LAW												
Address Line 1:	P.O. BOX 65745												
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20035												
ATTORNEY DOCKET NUMBER:	D91058.0103												
NAME OF SUBMITTER:	SHABNAM NOWROUZI												
Signature:	/Shabnam Nowrouzi/												

Date:

02/06/2014

Total Attachments: 3

source=NTFMP20130917_D910580103_20140206LFCE_CDA#page1.tif

source=NTFMP20130917_D910580103_20140206LFCE_CDA#page2.tif

source=NTFMP20130917_D910580103_20140206LFCE_CDA#page3.tif

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)**DECLARATION**

As a below-named inventor, I hereby declare that this declaration is directed to the application attached hereto, or to United States Application Number or PCT International Application Number 29/466,175 filed on September 5, 2013 (if applicable), entitled:

NOTEBOOK COMPUTER

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the above-identified application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the above-identified application, including the claims.

I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR 1.55, including for continuation-in-part applications, material information that became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

ASSIGNMENT

For valuable consideration, I, as a below-named assignor, hereby assign to:

Samsung Electronics Co., Ltd.
129, Samsung-ro, Yeongtong-gu
Suwon-si, Gyeonggi-do 443-742
Republic of Korea

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title, and interest throughout the world in the inventions and improvements that are the subject of the application identified in the above declaration, which is United States Application Number or PCT International Application Number 29/466,175 filed on September 5, 2013.

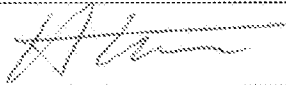
I authorize and request the attorneys appointed in the above-identified application to hereafter complete this Assignment by inserting above the application number and the filing date of the above-identified application when known, and to correct any typographical errors that may be discovered in this Assignment.

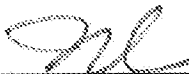
This Assignment includes the above-identified application, any and all United States and foreign patents, utility models, and design registrations granted for any of the inventions and improvements that are the subject of the above-identified application, and the right to claim priority based on the filing date of the above-identified application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of

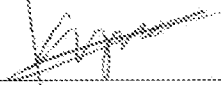
COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.


in witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

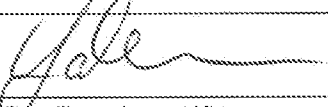
Inventor's Legal Name	Whan Oh SUNG		
Inventor's Signature		Date	2013. 9. 12
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	111-910 Shinbanpo Hansin Apt., Jamwon-dong, Seocho-gu, Seoul, Republic of Korea		

Inventor's Legal Name	Jooyeon LEE		
Inventor's Signature		Date	2013. 9. 13
Residence (City, Country)	Gunposi, Republic of Korea		
Mailing Address	106-1302 Sanbon 2cha e-Pyeonhan Sesang, Sanbon-dong 310-2, Gunposi, Kyunggi-do, Republic of Korea		

Inventor's Legal Name	Kyu Eun HWANG		
Inventor's Signature		Date	2013. 9. 13
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	110-1201 Lotte Apt., Guro-5dong, Guro-gu, Seoul, Republic of Korea		

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

Inventor's Legal Name	Youngkeun LEE		
Inventor's Signature		Date	2013. 9. 11
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	107-604, Lunavalley, Wulkok Raemian, Hawuikok-dong, Sungbuk-gu, Seoul, Republic of Korea		

Inventor's Legal Name	Jochen BACKS		
Inventor's Signature		Date	2013. 11. 5
Residence (City, Country)	San Francisco, USA		
Mailing Address	524 Washington Street, San Francisco, California USA 94111		